

BGM1032N7E6327XUSA1 Information


For Reference Only

Part Number [BGM1032N7E6327XUSA1](#)
Manufacturer Infineon Technologies
Category RF/IF and RFID
[RF Misc ICs and Modules](#)
Description MODULE GPS FRONT-END TSNP-7-10
Package 6-WDFN Exposed Pad
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


BGM1032N7E6327XUSA1 Specifications

Manufacturer Part Number	BGM1032N7E6327XUSA1
Manufacturer	Infineon Technologies
Category	RF/IF and RFID RF Misc ICs and Modules
Package	6-WDFN Exposed Pad
Series	-
Function	GPS Front End
Frequency	1575.42MHz
RF Type	GPS
Secondary Attributes	-
Package / Case	6-WDFN Exposed Pad
Supplier Device Package	TSNP-7-10
Report errors?	

BGM1032N7E6327XUSA1 Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.


Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BGM1032N7E6327XUSA1 Payment Methods



BGM1032N7E6327XUSA1 Shipping Methods



If you have any question about BGM1032N7E6327XUSA1, please do not hesitate to contact us!

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